

STD105N10F7AG

Automotive-grade N-channel 100 V, 6.8 mΩ typ., 80 A, STripFET™ F7 Power MOSFET in a DPAK package

Datasheet - production data

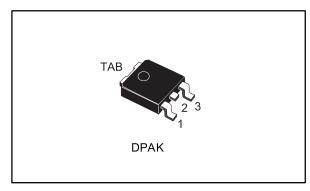
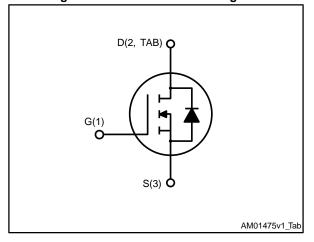


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	V _{DS} R _{DS(on)} max.		Ртот
STD105N10F7AG	100 V	8 mΩ	80 A	120 W

- Designed for automotive applications and AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness

Applications

Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packing
STD105N10F7AG	105N10F7	DPAK	Tape and reel

Contents STD105N10F7AG

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STD105N10F7AG Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	100	V	
V _{GS}	Gate-source voltage	± 20	V	
I _D	Drain current (continuous) at T _C = 25 °C	80	Α	
I _D	Drain current (continuous) at T _C = 100 °C	62	Α	
I _{DM} ⁽¹⁾	Drain current (pulsed) 320			
Ртот	Total dissipation at T _C = 25 °C 120			
T _{stg}	Storage temperature range		°C	
TJ	Operation junction temperature range	-55 to 175 °C		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case		°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb 50		

Notes:

Table 4: Avalanche characteristics

	Symbol	Parameter	Value	Unit
I	Eas	Single pulse avalanche energy $T_J = 25 ^{\circ}\text{C}$, $L = 3.5 \text{mH}$, $I_{AS} = 15 \text{A}$, $V_{DD} = 50 \text{V}$, $V_{GS} = 10 \text{V}$	400	mJ

⁽¹⁾Pulse width limited by safe operating area.

⁽¹⁾When mounted on FR-4 board of 1 inch², 2oz Cu.

Electrical characteristics STD105N10F7AG

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5: On/Off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage (V _{GS} = 0)	I _D = 250 μA	100			V
	Zero gate voltage	V _{DS} = 100 V			1	μΑ
drain current (V _{GS} = 0		$V_{DS} = 100 \text{ V}, T_{C} = 125 {}^{\circ}\text{C} {}^{(1)}$			100	μΑ
Igss	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2.5		4.5	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 40 A		6.8	8	mΩ

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	4369	•	pF
Coss	Output capacitance	$V_{DS} = 50 \text{ V}, f = 1 \text{ MHz},$	-	823	•	pF
Crss	Reverse transfer capacitance	V _G S = 0 V		36	-	pF
Qg	Total gate charge	$V_{DD} = 50 \text{ V}, I_D = 80 \text{ A},$	-	61	•	nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	26	ı	nC
Q_{gd}	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	13	ı	nC

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 50 \text{ V}, I_D = 40 \text{ A},$	•	27	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$		40	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 13: "Test circuit for resistive load switching times"	-	46	-	ns
t _f	Fall time	and Figure 18: "Switching time waveform")	-	15	-	ns

⁽¹⁾Defined by design, not subject to production test.

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		ı		80	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		ı		320	Α
V _{SD} ⁽²⁾	Forward on voltage I _{SD} = 80 A, V _{GS} = 0 V		-		1.2	V
t _{rr}	Reverse recovery time		ı	77		ns
Qrr	Reverse recovery charge $I_{SD} = 80 \text{ A, di/dt} = 100 \text{ A/µs}$ $V_{DD} = 80 \text{ V, T}_{I} = 150 ^{\circ}\text{C}$		-	146		nC
I _{RRM}	Reverse recovery current	- VDD - 00 V, 1j - 100 O	-	4		Α

Notes:

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s,}$ duty cycle 1.5 %.

2.1 Electrical characteristics (curves)

Figure 3: Thermal impedance

K $\delta = 0.5$ 0.2

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0.05 $Z_{\text{th}} = k R_{\text{th}, J-c}$ $\delta = f_{\text{p}}/T$ SINGLE PULSE

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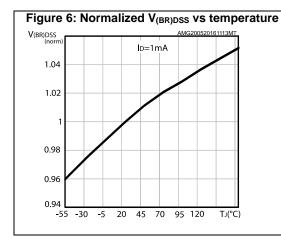
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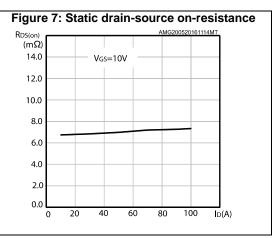
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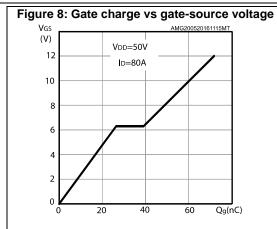
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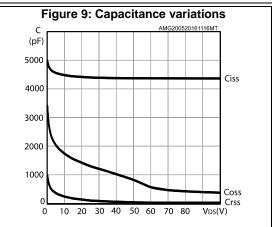
Figure 4: Output characteristics

ID
(A)
300
250
8V
200
150
7V
100
50
0
1 2 3 4 VDS(V)









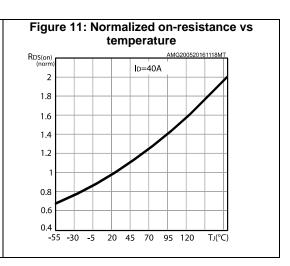
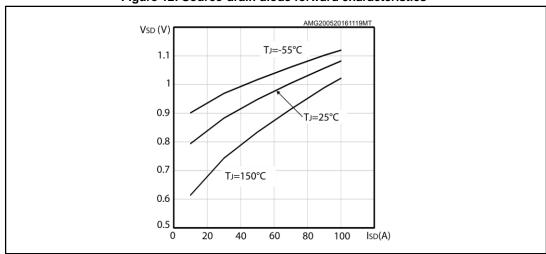


Figure 12: Source-drain diode forward characteristics



Test circuits STD105N10F7AG

3 Test circuits

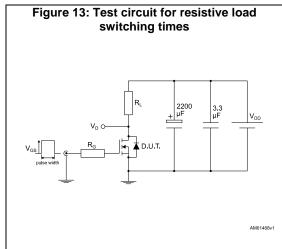
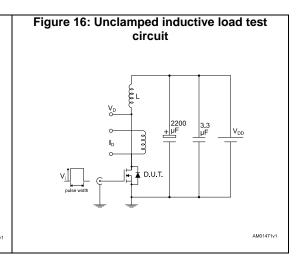


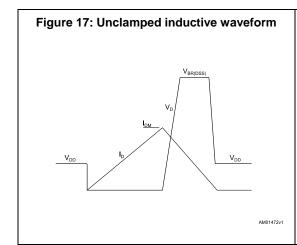
Figure 14: Test circuit for gate charge behavior

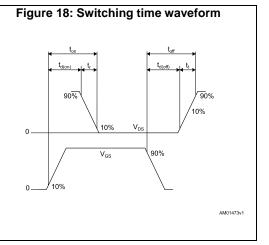
12 V 47 KΩ 100 Ω D.U.T.

12200 VG 47 KΩ VG AM01469v1

Figure 15: Test circuit for inductive load switching and diode recovery times







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 DPAK (TO-252) type A2 package information

Figure 19: DPAK (TO-252) type A2 package outline

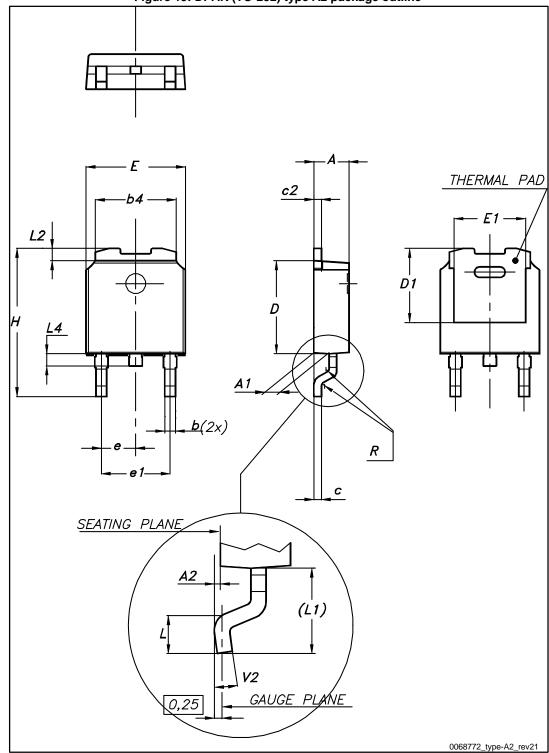
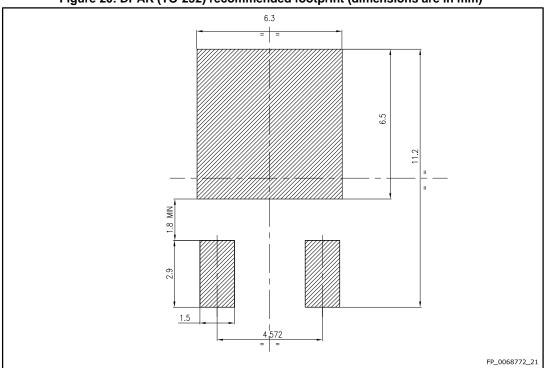


Table 9: DPAK (TO-252) type A2 mechanical data

Dim	145000000000000000000000000000000000000	mm	
Dim.	Min.	Тур.	Max.
Α	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	5.10	5.20	5.30
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

Package information STD105N10F7AG





STD105N10F7AG Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
23-Oct-2014	1	First release.
30-Oct-2014	2	Document status promoted from preliminary to production data.
20-May-2016	3	Updated Section 4.1: "DPAK (TO-252) type A2 package information". Minor text changes.
03-Jun-2016	4	Updated title and features in cover page. Updated <i>Table 5: "On/Off states"</i> . Minor text changes.

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